# onsemi

# **MOSFET** - Power, Single N-Channel, TDFNW8 DUAL COOL<sup>®</sup>

150 V, 4.45 mΩ, 174 A NTMTSC4D3N15MC

#### Features

- Small Footprint (8x8 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Typical Applications**

- Power Tools, Battery Operated Vacuums
- UAV/Drones, Material Handling
- BMS/Storage, Home Automation

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

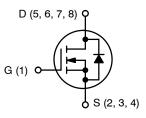
Symbol	Parameter			Value	Unit
V <sub>DSS</sub>	Drain-to-Source Voltage			150	V
V <sub>GS</sub>	Gate-to-Source Voltag	е		±20	V
Ι <sub>D</sub>	Continuous Drain Current $R_{\theta JC}$ (Note 2)	Steady State	$T_C = 25^{\circ}C$	174	A
PD	Power Dissipation $R_{\theta JC}$ (Note 2)			293	W
۱ <sub>D</sub>	Continuous Drain Current R <sub>θJA</sub> (Notes 1, 2)	Steady State	T <sub>A</sub> = 25°C	22	A
PD	Power Dissipation $R_{\theta JA}$ (Notes 1, 2)			5	W
I <sub>DM</sub>	Pulsed Drain Current	$T_A = 25^{\circ}C$ , $t_p = 10 \ \mu s$		900	А
T <sub>J</sub> , T <sub>stg</sub>	Operating Junction and Storage Temperature Range		–55 to +175	°C	
I <sub>S</sub>	Source Current (Body Diode)			244	А
E <sub>AS</sub>	Single Pulse Drain-to-Source Avalanche Energy (I <sub>L</sub> = 48.5 A <sub>pk</sub> , L = 0.3 mH)			354	mJ
ΤL	Lead Temperature Sold Soldering Purposes (1/	e Soldering Reflow for es (1/8″ from case for 10 s)			°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

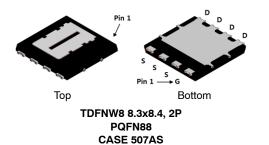
1. Surface-mounted on FR4 board using 1 in<sup>2</sup> pad size, 1 oz Cu pad.

2. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted

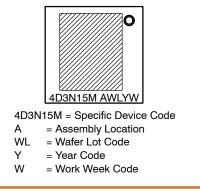
V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX	
150 V	$4.45~\mathrm{m}\Omega @ 10~\mathrm{V}$	174 A	
150 V	5 mΩ @ 8 V		



**N-CHANNEL MOSFET** 



MARKING DIAGRAM



#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTMTSC4D3N15MC	TDFNW8 (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### THERMAL RESISTANCE RATINGS

Symbol	Parameter	Max	Unit
$R_{ heta JC}$	Junction-to-Case - Steady State (Note 2)	0.5	°C/W
$R_{ heta JC}$	Junction-to-Top Source - Steady State (Note 2)	0.8	
$R_{ heta JA}$	Junction-to-Ambient - Steady State (Note 2)	30	

#### ELECTRICAL CHARACTERISTICS (T<sub>.1</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHARACT	ERISTICS	•		•	•		•
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		150	-	-	V
V <sub>(BR)DSS</sub> / T <sub>J</sub>	Drain-to-Source Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, ref to 25°C		-	49.84	_	mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 120 V	0 V, T <sub>J</sub> = 25°C	-	-	1	μΑ
		V <sub>DS</sub> = 120 V	T <sub>J</sub> = 125°C	-	-	10	μA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{DS} = 0 V, V_{GS}$	= ±20 V	-	-	±100	nA
ON CHARACTE	ERISTICS (Note 3)						
V <sub>GS(TH)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D =$	= 521 μA	2.5	3.6	4.5	V
V <sub>GS(TH)</sub> / T <sub>J</sub>	Negative Threshold Temperature Coefficient	I <sub>D</sub> = 250 μA, ref	to 25°C	-	-9.93	-	mV/°C
R <sub>DS(on)</sub>	Drain-to-Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 95 \text{ A}$ $V_{GS} = 8 \text{ V}, \text{ I}_{D} = 47 \text{ A}$		-	3.4	4.45	mΩ
				-	3.7	5	
9FS	Forward Transconductance	$V_{DS}$ = 5 V, $I_D$ =	95 A	-	177	-	S
R <sub>G</sub>	Gate-Resistance	T <sub>A</sub> = 25°C		-	1.1	-	Ω
HARGES & C	APACITANCES	-		-	-		
C <sub>ISS</sub>	Input Capacitance	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 75 V		-	6514	-	pF
C <sub>OSS</sub>	Output Capacitance			-	1750	-	
C <sub>RSS</sub>	Reverse Transfer Capacitance			-	12.5	-	
Q <sub>G(TOT)</sub>	Total Gate Charge	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 75 V, I <sub>D</sub> = 95 A		-	79	-	nC
Q <sub>G(TH)</sub>	Threshold Gate Charge			-	21	-	
Q <sub>GS</sub>	Gate-to-Source Charge			-	36	-	
Q <sub>GD</sub>	Gate-to-Drain Charge			-	11	-	1
V <sub>GP</sub>	Plateau Voltage	-		-	5.8	-	1
Q <sub>OSS</sub>	Output Charge	$V_{GS} = 0 V, V_{DS}$	= 75 V	-	225	-	nC
	HARACTERISTICS, V <sub>GS</sub> = 10 V (Note 3)	•		•			
t <sub>d(ON)</sub>	Turn – On Delay Time	V <sub>GS</sub> = 10 V, V <sub>D</sub>	<sub>S</sub> =75 V,	-	38	-	ns
t <sub>r</sub>	Rise Time	I <sub>D</sub> = 95 A, R <sub>G</sub> =	6 Ω	-	11	-	
t <sub>d(OFF)</sub>	Turn – Off Delay Time	-		-	48	-	1
t <sub>f</sub>	Fall Time			-	8	-	
RAIN-SOURC	CE DIODE CHARACTERISTICS	•		-	-	-	-
V <sub>SD</sub>	Forward Diode Voltage	V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 25°C	-	0.86	1.2	V
		I <sub>S</sub> = 95 A	T <sub>J</sub> = 125°C	-	0.80	-	
t <sub>RR</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/μs,		-	85	-	ns
ta	Charge Time	I <sub>S</sub> = 95 A		_	58	_	1
		-			1		4

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.3. Switching characteristics are independent of operating junction temperatures

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194

nC

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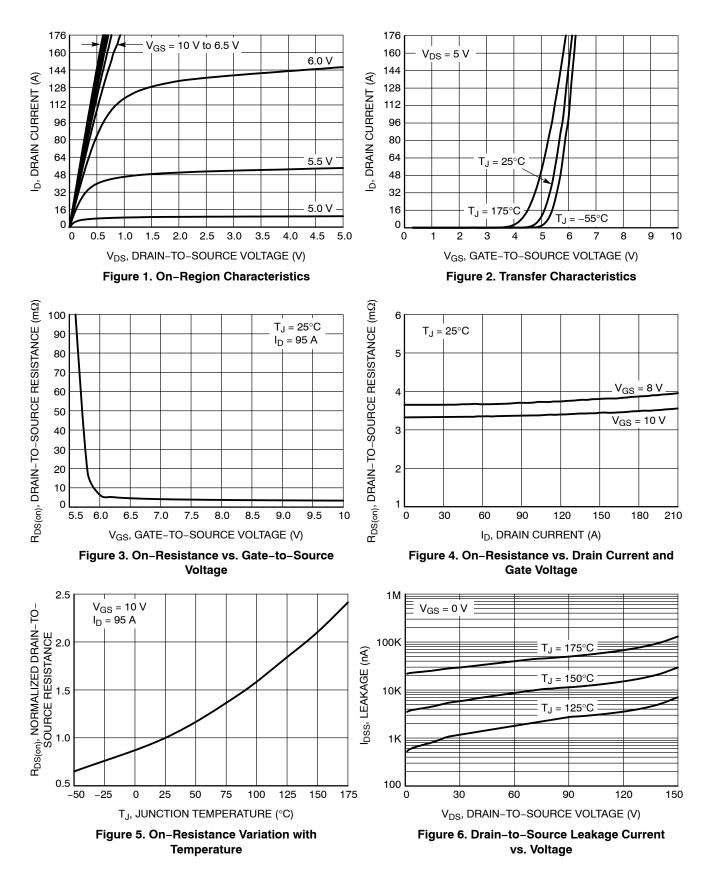
Discharge Time

**Reverse Recovery Charge** 

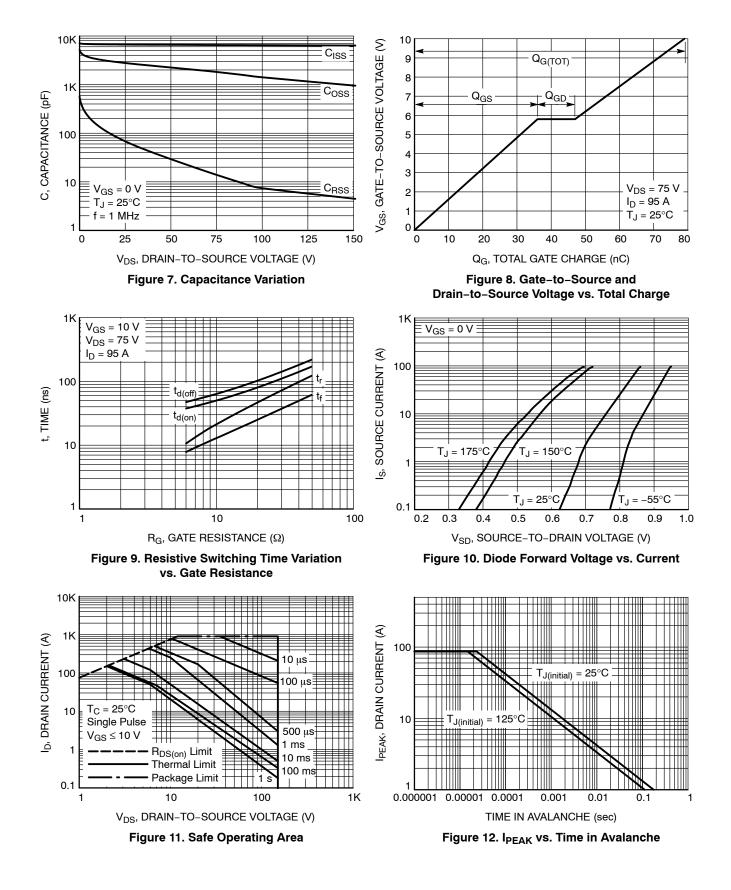
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#### **TYPICAL CHARACTERISTICS**



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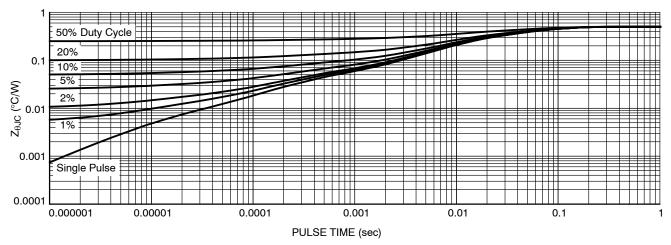
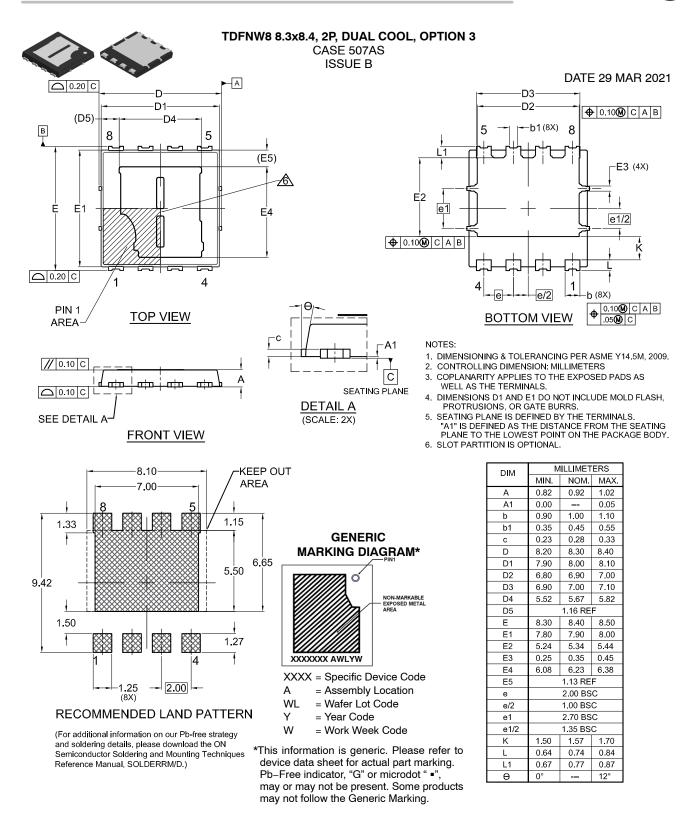


Figure 13. Thermal Characteristics

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